Mar, 2020

## Product Spec Sheet Multitrack Recording Console **Model 12**





## Specifications

#### General Supported media SD cards (Class 10 or more) SDHC cards (Class 10 or more) SDXC cards (Class 10 or more) •File System SD card: FAT16 SDHC card: FAT32 SDXC card: exFAT Recording file formats WAV (BWF): 44.1/48 kHz, 16/24-bit (Maximum file size: 2 GB) Playback file formats WAV (BWF): 44.1/48 kHz, 16/24-bit Recordable Channel Max. 12 channels (10 ch + 2 stereo mix)

Inputs and outputs	
Analog audio input and c	output ratings
•MIC input jacks (1–6, 7, 9)	
Connectors:	XLR-3-31 (1: GND, 2: HOT, 3: COLD)
Maximum input level:	+10 dBu
Nominal input level:	-8 dBu
Minimum input level:	-58 dBu
Gain adjustment range:	0 – 50 dB
Input impedance:	1.8 kΩ
<ul> <li>LINE (BAL)/INST input jack</li> </ul>	
Connectors:	6.3 mm (1/4") standard TRS jacks (Tip: HOT, Ring: COLD, Sleeve: GND)
Maximum input level:	+22 dBu (LINE)/19.8 dBV (INST)
Nominal input level:	+4 dBu (LINE)/1.8 dBV (INST)
Gain adjustment range:	-10 - +40  dB
Input impedance:	$22 \text{ k}\Omega(\text{LINE})/1 \text{ M}\Omega(\text{INST})$
·L/MONO (BAL)/INST input	
Connectors:	6.3 mm (1/4") standard TRS jacks (Tip: HOT, Ring: COLD, Sleeve: GND)
Maximum input level:	+22 dBu (LINE)/19.8 dBV (INST)
Nominal input level:	+4 dBu (LINE)/1.8 dBV (INST)
Gain adjustment range:	-20 - +30  dB
Input impedance:	$18 \text{ k}\Omega(\text{LINE})/1 \text{ M}\Omega(\text{INST})$
•R (BAL) input jacks (8, 10)	
Connectors:	6.3 mm (1/4") standard TRS jacks (Tip: HOT, Ring: COLD, Sleeve: GND)
Maximum input level:	+22 dBu
Nominal input level:	+4 dBu
Gain adjustment range:	-20 - +30 dB
Input impedance:	18 kΩ
•INSERT jacks (1-2)	
Connectors:	6.3 mm (1/4") standard TRS jacks (Tip: SEND, Ring: RETURN, Sleeve: GND)
RETURN (Ring)	
Nominal input level:	0 dBu
Maximum input level:	+18 dBu
Input impedance:	5 kΩ
SEND (Tip)	
Nominal output level:	0 dBu
Maximum output level:	+18 dBu
Output impedance:	100 Ω
•MUSIC/TALK jack (9/10)	
Connector:	3.5 mm (1/8") 4-pole mini jack (Tip: L, Ring1: R, Ring2: GND, Sleeve: MIC)
Maximum input level:	+8 dBV
Nominal input level:	-10 dBV
Input impedance:	10 kΩ
•MAIN OUTPUT L/R jacks	
Connectors:	XLR-3-32 (1: GND, 2: HOT, 3: COLD)
Nominal output level:	+4 dBu
	+22 dBu
Maximum output level:	200 Ω
Output impedance: •SUB OUTPUT L/R jacks	
Connectors:	6.3 mm (1/4") standard TRS jacks (Tip: HOT, Ring: COLD, Sleeve: GND)
Nominal output level::	−2 dBu
Maximum output level:	+16 dBu
Output impedance:	200 Ω

## •AUX OUTPUT AUX 1/2 jacks

(S
6.3 mm (1/4") standard TRS jacks (Tip: HOT, Ring: COLD, Sleeve: GND)
−2 dBu
+16 dBu
200 Ω
6.3 mm (1/4") standard stereo jack
45 mW + 45 mW (32 Ωload)
4-pin USB C-type
USB 2.0 HIGH SPEED (480 Mbps)
6.3 mm (1/4") standard TS jacks (Tip: HOT, Sleeve: GND)
6.3 mm (1/4") standard TRS jacks (Tip: FOOTSW1, Ring: FOOTSW2,
Sleeve: GND, Unlatch type correspondence)
5-pin DIN
standard MIDI
5-pin DIN
standard MIDI

## Computer system requirements

Check the TEAC Global Site (http://teac-global.com/) for the latest information about supported operating systems.

#### Windows

<ul> <li>Supported operating systems</li> </ul>
Windows 10 32-bit
Windows 10 64-bit
Windows 8.1 32-bit
Windows 8.1 64-bit
Windows 7
(Operation has been confirmed with the final version of Windows 7.)
Windows 7 32-bit SP1 or later
Windows 7 64-bit SP1 or later
<ul> <li>Computer hardware requirements</li> </ul>
Windows computer with a USB 2.0 (or higher) port

#### •CPU/processor speed

2 GHz or faster dual core processor (x86)

#### Memory

2 GB or more

## ATTENTION

Operation of this unit was confirmed using standard computers that meet the above requirements. This does not guarantee operation with all computers that meet the above requirements. Even computers that meet the same system requirements might have processing capabilities that differ according to their settings and other operating conditions.

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#### Mac

#### • Supported operating systems macOS Catalina (10.15)

macOS Mojave (10.14 or later)

macOS High Sierra (10.13 or later)

- •Computer hardware requirements
- Mac with a USB 2.0 (or higher) port

## CPU/processor speed

2 GHz or faster dual core processor

## Memory

2 GB or more

## iOS device

Operation has been confirmed with Apple devices running the following iOS versions.

iOS 13 iOS 12

iOS 11

## Supported audio drivers

## •Windows

ASIO2.0, WDM

## •Mac

Core Audio

## •iOS divice

Core Audio for iPhone

## Audio performance

## •S/N ratio

103 dB (MAIN MIX & 1Ch 0 dB, 22 kHz, A-weighted)

## •Equivalent input noise (EIN)

-128 dBu (Rs = 150  $\Omega$  MIC IN  $\rightarrow$  INSERT SEND, gain knob at MAX, A-weighted)

## Total harmonic distortion ratio (THD+N)

0.003% (MONO MIC IN  $\rightarrow$  MAIN OUT, +2 dBu, 1 kHz, gain knob at MIN)

#### Frequency response

20 Hz to 20 kHz (+0.1/–0.15 dB, 1 kHz, MIC IN  $\rightarrow$  MAIN OUT)

#### Crosstalk

(PAN knobs turned completely left or right, 1 kHz) Between channels: -95 dB

Between input and output: -95 dB

## Maximum gain

(All GAIN knobs maximized, PAN knobs turned completely left or right, EQ knobs and MASTER SECTION EQ knobs at middle positions)

MIC $\rightarrow$ MAIN OUT:	74 dB
MIC $\rightarrow$ INSERT OUT:	54 dB
MIC $\rightarrow$ SUB OUT:	74 dB
MIC $\rightarrow$ AUX OUT:	75 dB
USB/SD $\rightarrow$ MAIN OUT:	24 dB

## <u>Bluetooth</u>

<ul> <li>Bluetooth version: 5.0</li> </ul>	
Output class:	2 (about 10 m* unobstructed transmission distance)
Supported profiles:	A2DP



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Supported A2DP codecs: SBC, AAC Supported A2DP content protection: SCMS-T

\* The transmission distance is only an estimate and might vary depending on the surrounding environment and radio wave conditions.

## <u>Other</u>

#### Power

Dedicated AC adapte	er (PS-M1524A)
Input voltage:	AC 100 – 240 V~, 50/60 Hz
Output voltage:	DC 15 V
Output current:	2.4 A
•Power consumption	
16 W	
<ul> <li>Dimensions</li> </ul>	
343.0 × 98.8 × 3	60.0 mm (W x H x D, including protrusions)
•Weight	
4.3 kg	
• Operating temperature	e range
5 – 35°C (41 – 95°F	)

Dimensional drawings





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